

Silicon Carbide Power Schottky Diode

Features

- 1200 V Schottky rectifier
- 175 °C maximum operating temperature
- Zero reverse recovery charge
- \bullet Positive temperature coefficient of $V_{\rm \scriptscriptstyle F}$
- Extremely fast switching speeds
- Temperature independent switching behavior
- Lowest figure of merit Q_C/I_F

Advantages

- Improved circuit efficiency (Lower overall cost)
- Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

Maximum Ratings, at T_i = 175 °C, unless otherwise specified

Applications • Power Factor Correction (PFC)

• Switched-Mode Power Supply (SMPS)

Case

PIN 1 C

PIN 2 🔿

Solar Inverters

Package

RoHS Compliant

• Wind Turbine Inverters

TO - 247AC

- Motor Drives
- Induction Heating
- Uninterruptible Power Supply (UPS)
- Voltage Clamping

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V _{RRM}		1200	V
Continuous forward current	I _F	T _c ≤ 150 °C	10	А
RMS forward current	I _{F(RMS)}	T _c ≤ 150 °C	17	А
Surge non-repetitive forward current, Half Sine Wave	I _{F,SM}	T_{c} = 25 °C, t_{p} = 10 ms	tbd	А
Non-repetitive peak forward current	I _{F,max}	T _c = 25 °C, t _p = 10 μs	tbd	А
i²t value	∫i² dt	$T_{c} = 25 \text{ °C}, t_{p} = 10 \text{ ms}$	tbd	A ² s
Power dissipation	P _{tot}	T _c = 25 °C	190	W
Operating and storage temperature	T _j , T _{stg}		-55 to 175	°C

Electrical Characteristics, at T_i = 175 °C, unless otherwise specified

Parameter	Cumb of	Conditions	Values			11
	Symbol		min.	typ.	max.	Unit
Diode forward voltage	V	I _F = 10 A, T _j = 25 °C		1.70	1.8	V
	v _F	I _F = 10 A, T _j = 175 °C		3.00		
Reverse current	1	V _R = 1200 V, T _j = 25 °C		10	240	μA
	R	V _R = 1200 V, T _i = 175 °C		40	1000	
Total capacitive charge	Q _c	$V_{R} = 950 \text{ V}, \text{ I}_{F} \leq \text{ I}_{F,max}$		37		nC
Switching time	t _s	dI _F /dt = 330 A/µs, T _j = 150 °C		< 15		ns
Total capacitance	C	V _R = 3 V, f = 1 kHz, T _j = 25 °C		337		pF
	С	V _R = 200 V, f = 1 kHz, T _i = 25 °C		61		

Thermal Characteristics Thermal resistance, junction - case

Mechanical Properties			
Mounting torque	М	0.6	Nm

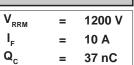
R_{thJC}

1. Considering worst case Z_{th} conditions

http://www.genesicsemi.com/index.php/silicon-carbide-products/schottky-rectifiers/discrete-rectifiers

°C/W

0.79

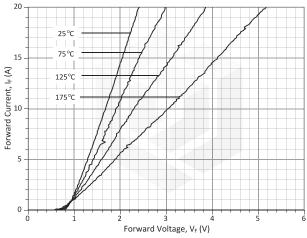


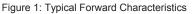
-O CASE

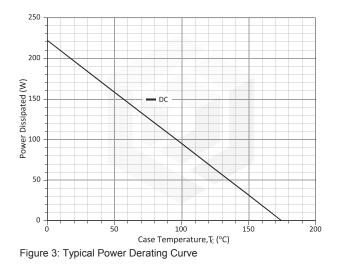
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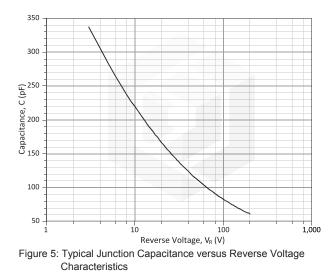


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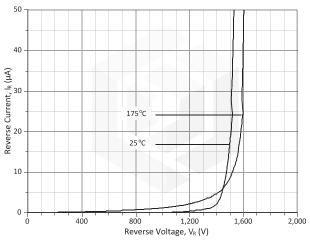
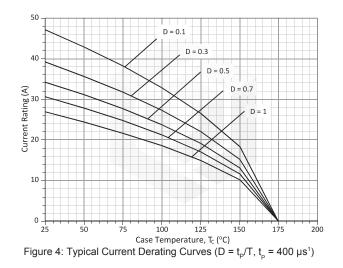
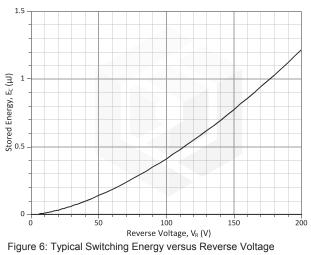


Figure 2: Typical Reverse Characteristics





Characteristics



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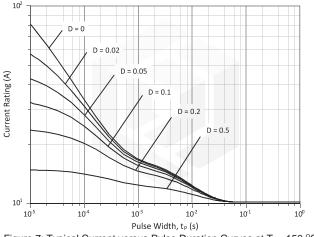


Figure 7: Typical Current versus Pulse Duration Curves at T_c =150 °C

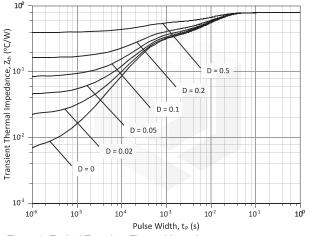
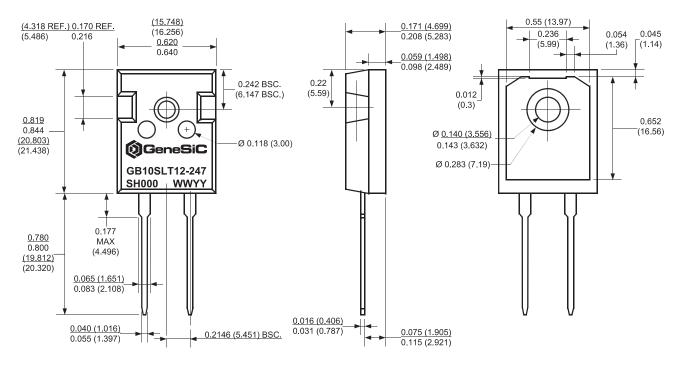


Figure 8: Typical Transient Thermal Impedance

Package Dimensions:



PACKAGE OUTLINE

TO-247AC

NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.

2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



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Revision History				
Date	Revision	Comments	Supersedes	
2010/01/24	1	Second generation release	GA10SLT12-247	

Published by GeneSiC Semiconductor, Inc. 43670 Trade Center Place Suite 155 Dulles, VA 20166

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